RoHS



Vishay General Semiconductor

Surface Mount TRANSZORB® Transient Voltage Suppressors



DO-214AA	(SMBJ)

PRIMARY CHARACTERISTICS					
V _{BR} (uni-directional)	4.1 V				
V _{WM}	3.3 V				
P _{PPM}	600 W				
P _D	5 W				
I _{FSM} (uni-directional only)	60 A				
T _J max.	175 °C				
Polarity	Uni-directional				
Package	DO-214AA (SMBJ)				

FEATURES

- Uni-directional polarity only
- Peak pulse power: 600 W (10/1000 μs)
- · Excellent clamping capability
- Very fast response time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lighting on ICs, MOSFET, signal lines of sensor units specifically for protecting 3.3 V supplied sensitive equipment against transient overvoltages.

MECHANICAL DATA

Case: DO-214AA (SMBJ)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant and commercial grade Base P/NHE3 - RoHS-compliant and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

J-31D-002 and JE3D 22-B102

E3 suffix meets JESD 201 class 2 whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	VALUE	UNIT			
Peak pulse power dissipation (1)(2)	P _{PPM}	600	W			
Peak pulse current with a 10/1000 µs waveform (fig. 1)	I _{PP}	50	Α			
Peak pulse current with a 8/20 µs waveform (fig. 1)	I _{PPM}	200	Α			
Peak forward surge current 8.3 ms single half sine-wave (2)	I _{FSM}	60	Α			
Power dissipation on infinite heatsink, T _A = 75 °C	P _D	5	W			
Operating junction and storage temperature range	T _J , T _{STG}	-65 to +175	°C			

Notes

- (1) Non-repetitive current pulse, per fig. 1
- (2) Mounted on 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pads to each terminal

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)													
DEVICE DEVICE		BREAKDOWN VOLTAGE V _{BR} AT I _T		LEAKAGE VOLTAG	VOLTAGE	VOLTAGE		CLAMPING VOLTAGE		TYPICAL TEMPERATURE COEFFICIENT	TYPICAL JUNCTION CAPACITANCE C.1 AT 0 V		
TYPE	MARKING CODE	MIN.		CURRENT I _R AT V _{WM}	V _{WM}		T I _{PP} 00 µs			V _C AT I _{PPM} 8/20 μs		V _C Al I _{PPM} OF V _{PP}	
		٧	mA	μA	V	٧	Α	٧	Α	10 ⁻⁴ /°C	pF		
SMBJ3V3	KC	4.1	1.0	200	3.3	7.3	50	10.3	200	-5.3	5200		



Vishay General Semiconductor

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	VALUE	UNIT			
Typical thermal resistance, junction to lead (1)	$R_{ heta JL}$	20	°C/W			
Typical thermal resistance, junction to ambient (2)	$R_{ hetaJA}$	100]			

Notes

- (1) Thermal resistance from junction to lead mounted on 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pads to each terminal
- (2) Thermal resistance from junction to ambient mounted on the recommended PCB pad layout

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
SMBJ3V3-E3/52	0.096	52	750	7" diameter plastic tape and reel		
SMBJ3V3-E3/5B	0.096	5B	3200	13" diameter plastic tape and reel		
SMBJ3V3HE3/52 (1)	0.096	52	750	7" diameter plastic tape and reel		
SMBJ3V3HE3/5B (1)	0.096	5B	3200	13" diameter plastic tape and reel		

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

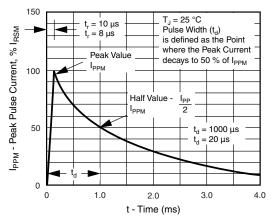


Fig. 1 - Pulse Wave Form

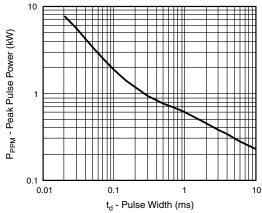


Fig. 2 - Peak Pulse Power Rating Curve

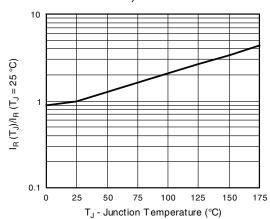


Fig. 3 - Relative Variation of Leakage Current vs. Junction Temperature

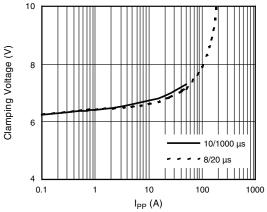


Fig. 4 - Clamping Voltage vs. Peak Pulse Current (T_J initial = 25 °C)



Vishay General Semiconductor

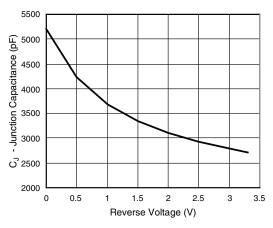
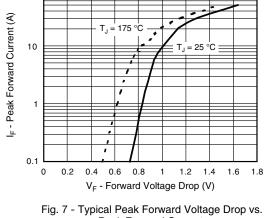


Fig. 5 - Typical Junction Capacitance



100

Peak Forward Current

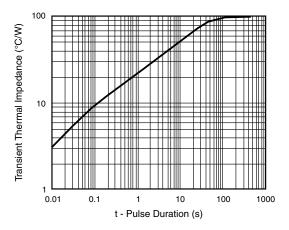


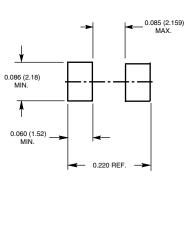
Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

Cathode Band 0.086 (2.20) 0.155 (3.94) 0.077 (1.95) 0.130 (3.30) 0.180 (4.57) 0.160 (4.06) 0.012 (0.305) 0.006 (0.152) 0.096 (2.44) 0.060 (1.52) 0 (0) 0.220 (5.59)

DO-214AA (SMB-J-Bend)

Mounting Pad Layout





Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000